

GRF5504

High Efficiency 3.5 Watt Power Amplifier 100 to 550 MHz

FEATURES

- Flexible Bias Voltage and Current
- 125 mA Native Mode Quiescent Current Consumption
- 5 V Supply Voltage
- -40 to 85 °C Operating Temperature Range
- Compact 3 x 3 mm QFN-16 Package
- Process: InGaP HBT

Reference: 5 V / 125 mA / 460 MHz

- Gain: 41 dB
- OP1dB: 34.3 dBm
- P_{SAT} : 35.5 dBm
- PAE: 61% at P_{SAT}
- Evaluation Board Noise Figure: 4.2 dB

APPLICATIONS

- UHF
- Automatic Meter Reader
- IOT
- TETRA

DESCRIPTION

The GRF5504 is a high efficiency PA that delivers up to 3.5 watts at P_{SAT} with V_{CC} at 5 volts and a low I_{CCQ} of 125 mA. PAE at P_{SAT} is roughly 61%.

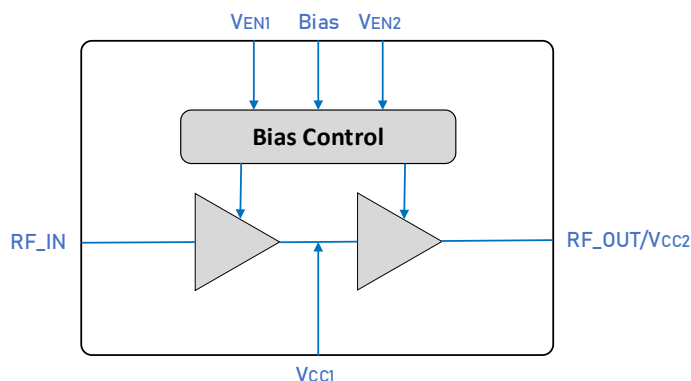
The device can be tuned over a range of frequencies from 100 MHz to 550 MHz with typical fractional bandwidths of 3 to 5%.

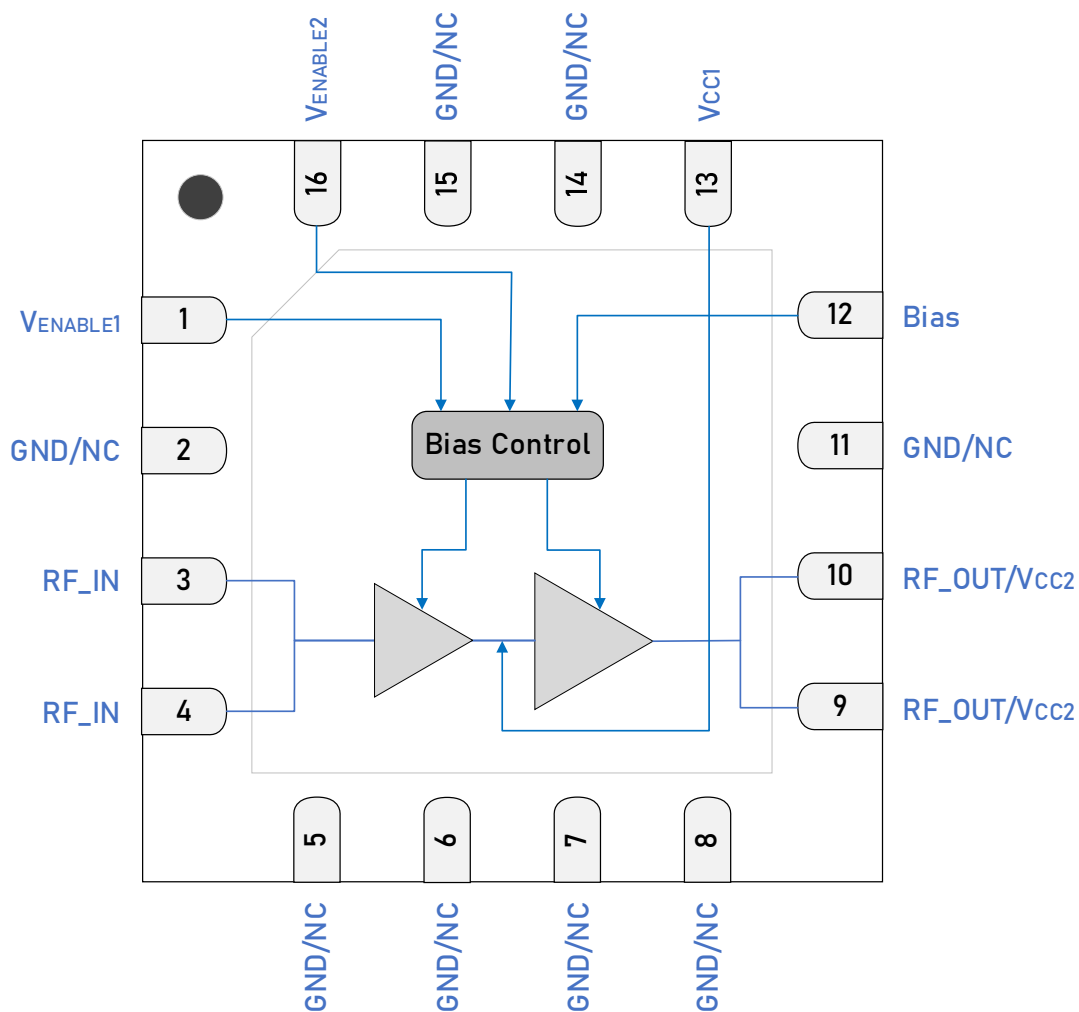
For frequencies in the 700-1000 MHz range, GRF5509 offers slightly higher output power and higher efficiency with the same package and pinout.

Please consult with the GRF applications engineering team for custom tuning/evaluation board data.

Additional tunes can be found on the GRF5504 "Custom Tunes" product page: [GRF5504 Custom Tunes](#)

BLOCK DIAGRAM





3 x 3 mm QFN-16 Pin Out (Top View)

Pin Assignments

Pin	Name	Description	Note
1	V _{ENABLE1}	Enable1 Voltage Input	V _{EN1} and series resistor sets I _{CCQ1} for the input stage. V _{EN1} ≤ 0.2 volts disables the device.
2, 5, 6, 7, 8, 11, 14, 15	GND/NC	Ground or No Connect	No internal connection to die. These pins can be left unconnected or connected to ground (recommended). Use a via as close to the pin as possible if grounded.
3, 4	RF_IN	RF Input	Pins 3 & 4 tied together on system board. Internally matched 50 Ω. An external DC blocking capacitor must be used.
9, 10	RF_OUT/V _{CC2}	PA Output/Bias Voltage	Pins 9 & 10 tied together on system board. V _{CC2} must be applied to this pin via an RF choke.
12	Bias	Bias Circuit Supply	Connect to V _{CC2} through an external resistor.
13	V _{CC1}	Bias Voltage	Connect to V _{CC1} through an external resistor.
16	V _{ENABLE2}	Enable2 Voltage Input	V _{EN2} and series resistor sets I _{CCQ2} for the output stage. V _{EN2} ≤ 0.2 volts disables the device.
PKG BASE	GND	Ground	Provides DC and RF ground for PA as well as thermal heat sink. Recommend multiple 8-mil vias beneath the package for optimal RF and thermal performance. Refer to evaluation board top layer graphic on schematic page.

Truth Table

Pin	Logic	Condition
V _{EN1}	LOW	Stage 1 Amplifier Off
	HIGH	Stage 1 Amplifier On
V _{EN2}	LOW	Stage 2 Amplifier Off
	HIGH	Stage 2 Amplifier On

Absolute Ratings

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage (see note).	V_{CC}	* 2.7	5.5	V
Transient Average RF Input Power: Load VSWR < 2:1.	$P_{IN\ MAX}$		20	dBm
Operating Temperature (package base).	$T_{PKG\ BASE}$	-40	85	°C
Maximum Junction Temperature (MTTF > 10 ⁶ hours).	$T_{J\ MAX}$		170	°C
Stage 1 Maximum Dissipated Power: DC only (no RF applied).	$P_{DISS\ MAX}$		500	mW
Stage 2 Maximum Dissipated Power: DC only (no RF applied).	$P_{DISS\ MAX}$		1750	mW
Ruggedness: $V_{CC} = 5\ V$ at P_{SAT} (all phase angles).	VSWR		TBD	--

* **Note:** device can be operated in saturated applications with $V_{CC} < 2.7\ V$. Please consult with the GRF applications team for details.

Electrostatic Discharge

Human Body Model	HBM	250		V
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Storage

Storage Temperature	T_{STG}	-65	150	°C
Moisture Sensitivity Level	MSL		1	--



Caution! ESD Sensitive Device

Exceeding Absolute Maximum Rating conditions may cause permanent damage to the device.

Note: For additional information, please refer to [Manufacturing Note MN-001 — Package and Manufacturing Information](#).



All Guerrilla RF products are provided in RoHS compliant lead (Pb)-free packaging requiring no exemptions. Additional information for this topic can be found at this link - [Environmental and Restricted Substance Statement Library](#)

Recommended Operating Conditions

Parameter	Symbol	Specification			Unit	Condition
		Min.	Typ.	Max.		
Supply Voltage	V_{CC}	2.7	5	5.5	V	
RF Frequency Range	F_{RF}	100	460	550	MHz	Typical application schematic using the 100 to 550 MHz tuning set (notes 1 & 2).
Operating Temperature Range	$T_{PKG\ BASE}$	-40		85	°C	
RF_IN Port Impedance	Z_{RF_IN}		50		Ω	Single-ended with 2 element match.
RF_OUT Port Impedance	Z_{RF_OUT}		50		Ω	Single-ended with 4 element match.

Note 1: Operation outside of this range is supported by using different custom tunes. Examples of other optimized tunes can be found here: [GRF5504 Custom Tunes](#)

Note 2: Contact the Guerrilla RF applications team for guidance on optimizing the tuning of the device for alternative bands.

Nominal Operating Parameters – General

The following conditions apply unless noted otherwise: typical application schematic. $V_{CC} = 5\text{ V}$, $F_{TEST} = 460\text{ MHz}$, $50\ \Omega$ system impedance, $T_{PKG\text{ BASE}} = 25\text{ }^{\circ}\text{C}$. Evaluation board losses are included within the specifications.

Parameter	Symbol	Specification			Unit	Condition
		Min.	Typ.	Max.		
Supply Current	I_{CCQ}	90	125	160	mA	$V_{CC} = 5\text{ V}$, $V_{EN1} = V_{EN2} = 5\text{ V}$.
Enable Current 1	$I_{ENABLE1}$		1.0		mA	$V_{CC} = 5\text{ V}$, $V_{EN1} = V_{EN2} = 5\text{ V}$.
Enable Current 2	$I_{ENABLE2}$		0.4		mA	$V_{CC} = 5\text{ V}$, $V_{EN1} = V_{EN2} = 5\text{ V}$.

Disabled Mode

Supply Current (leakage)	$I_{LEAKAGE}$		0.03		μA	$V_{CC} = 5\text{ V}$, $V_{EN1} = V_{EN2} = 0\text{ V}$.
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Thermal Data

Stage 1 Thermal Resistance (Infrared Scan). DC only (no RF applied).	Θ_{JC}		140		$^{\circ}\text{C/W}$	On standard evaluation board.
Stage 2 Thermal Resistance (Infrared Scan). DC only (no RF applied).	Θ_{JC}		33		$^{\circ}\text{C/W}$	On standard evaluation board.
Thermal Data Stage 1 and 2: see plot of junction temperature vs. output power.						$V_{CC} = 5\text{ V}$, $V_{EN1} = V_{EN2} = 5\text{ V}$. On standard evaluation board (note 3).

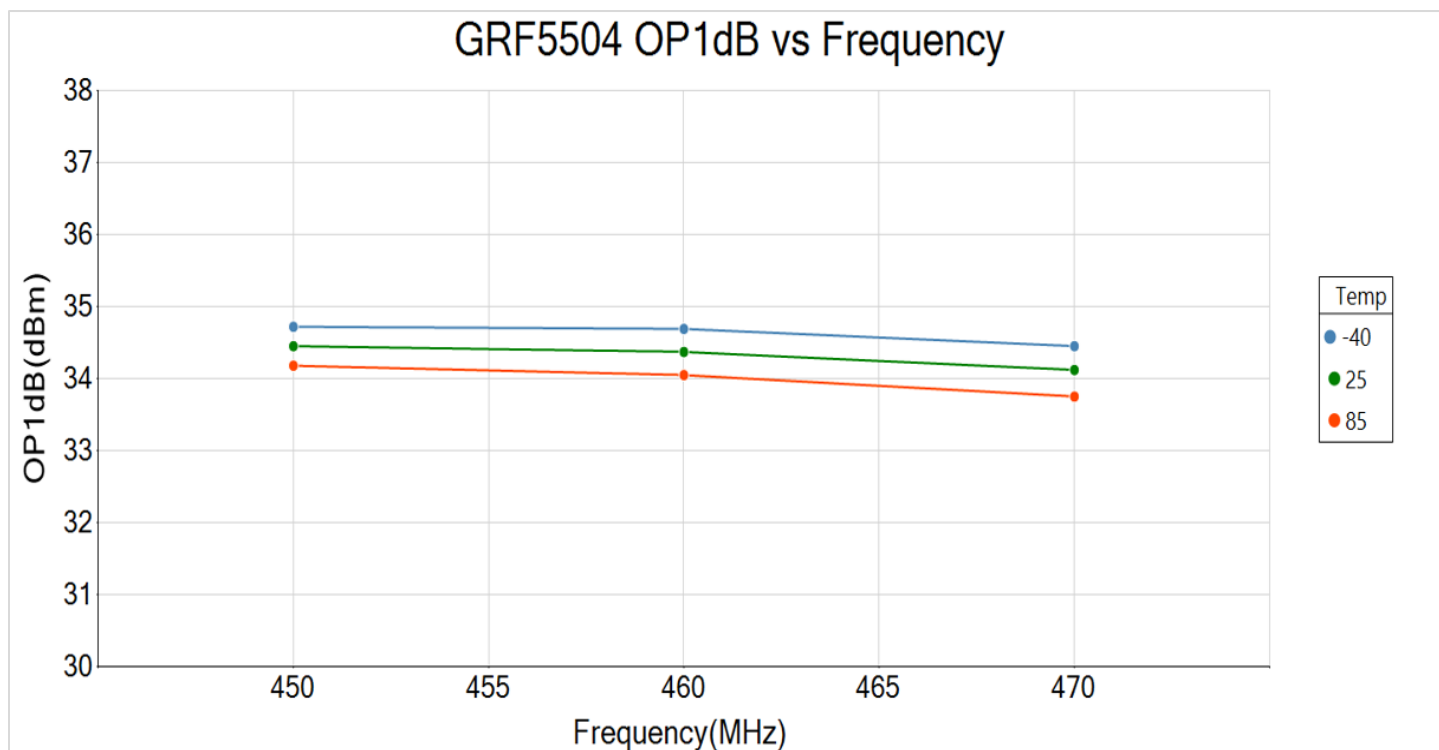
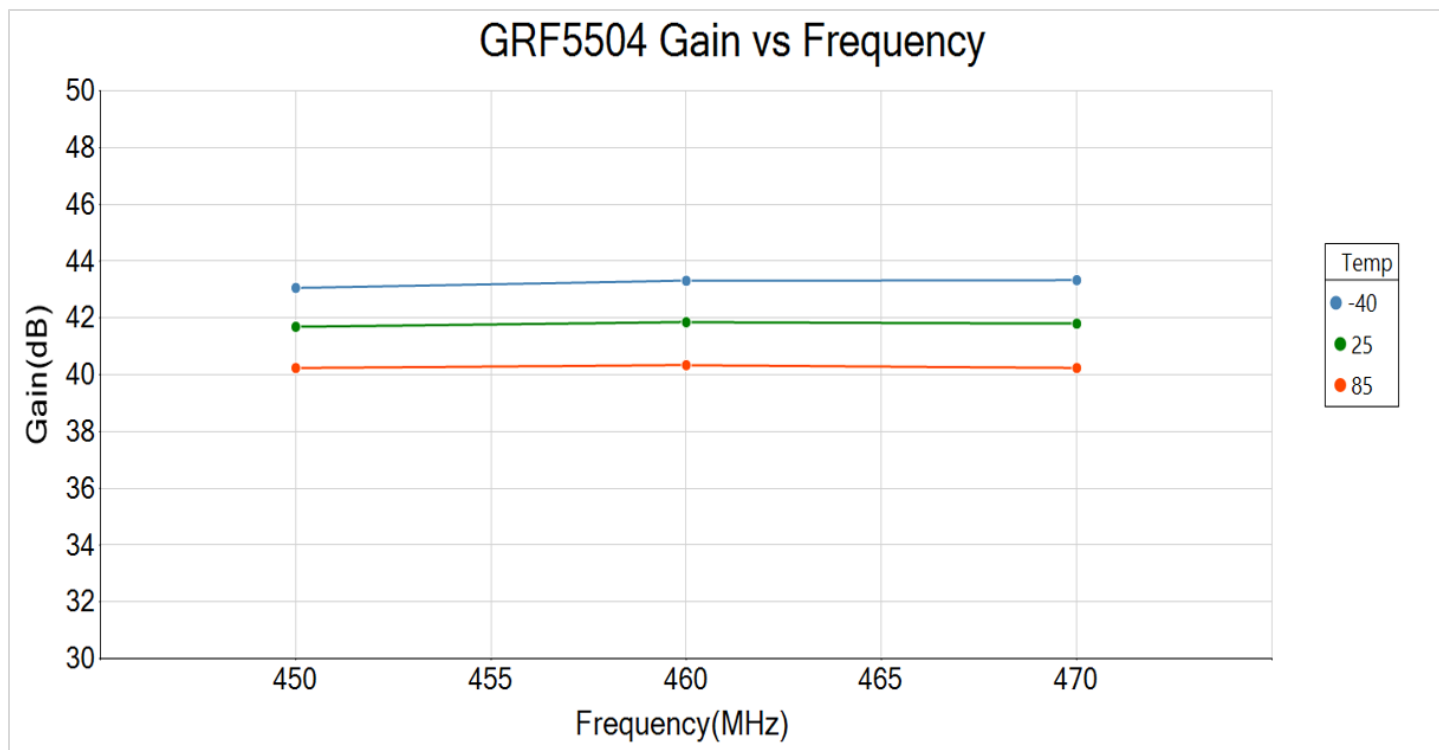
Note 3: MTTF > 10^6 hours for $T_j \leq 170\text{ }^{\circ}\text{C}$.

Nominal Operating Parameters – RF

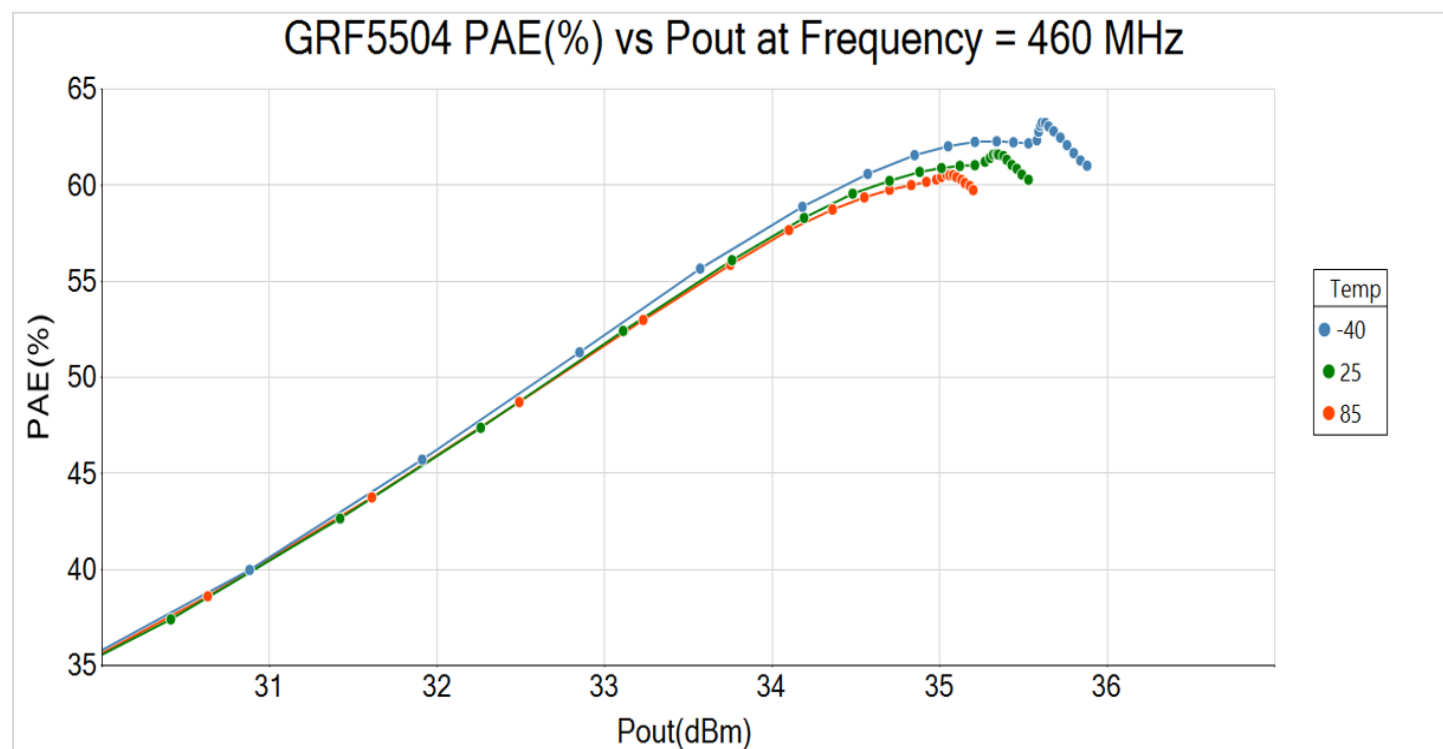
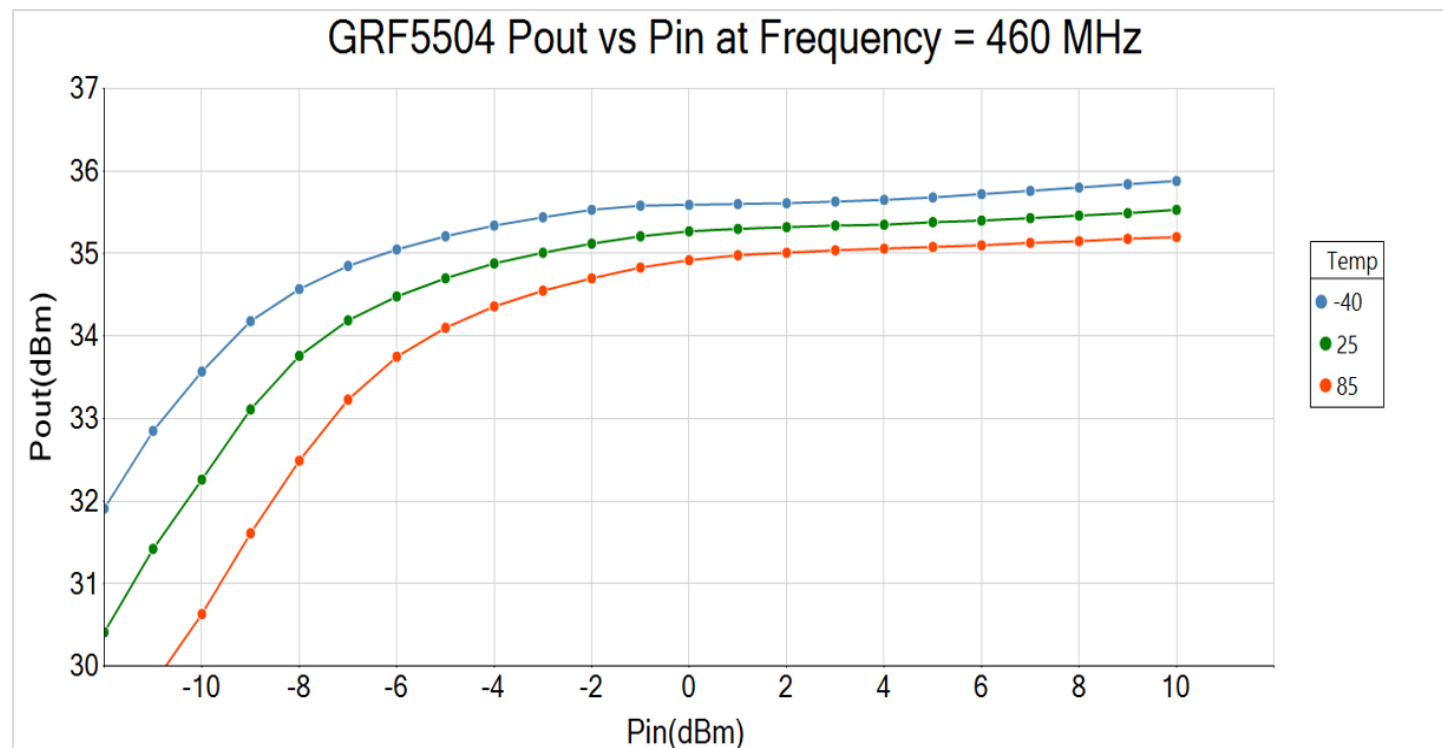
The following conditions apply unless noted otherwise: typical application schematic. $V_{CC} = 5\text{ V}$, $F_{TEST} = 460\text{ MHz}$, $50\ \Omega$ system impedance, $T_{PKG\text{ BASE}} = 25\text{ }^{\circ}\text{C}$. Evaluation board losses are included within the specifications.

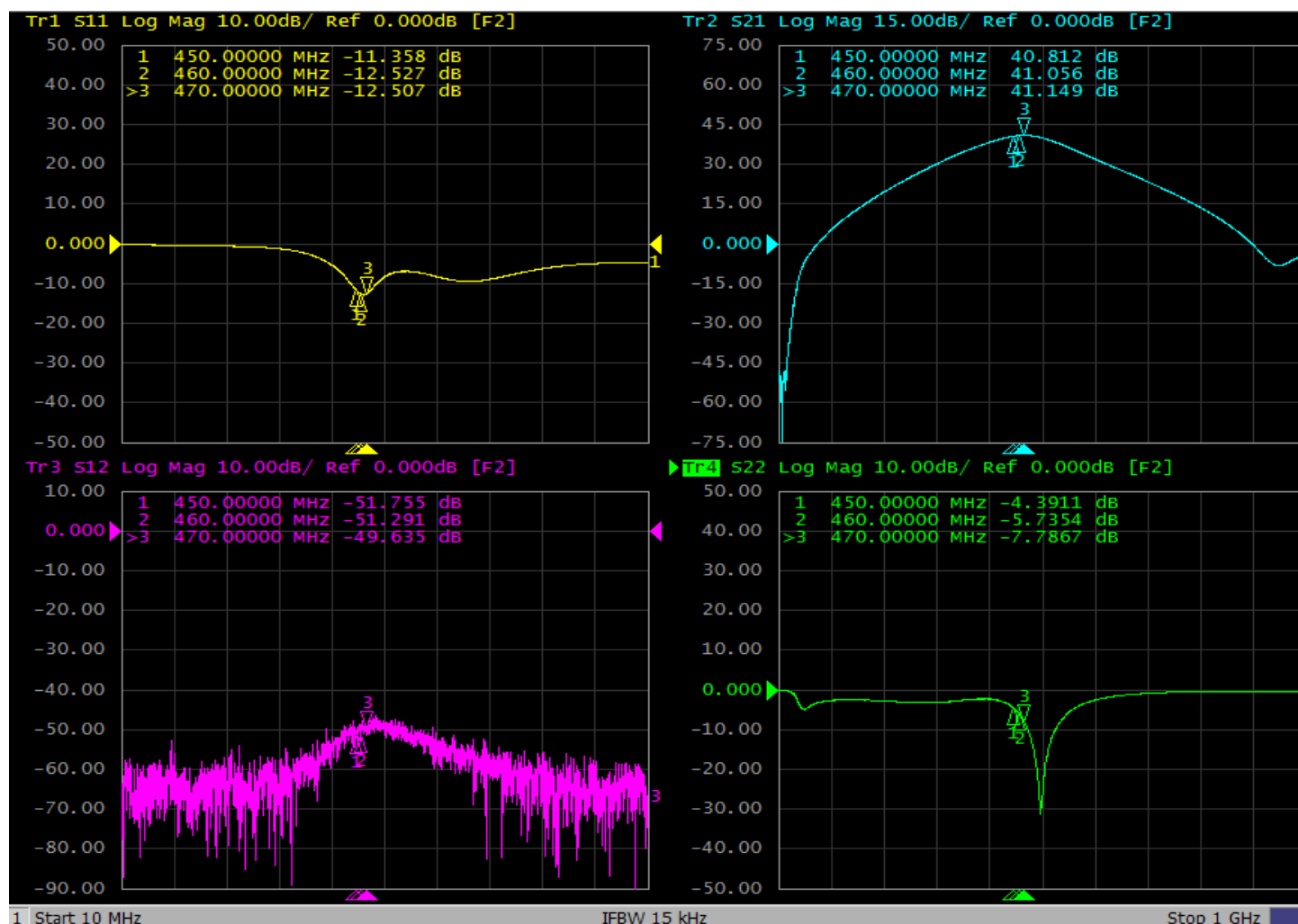
Parameter	Symbol	Specification			Unit	Condition
		Min.	Typ.	Max.		
Small Signal Gain	S21		41		dB	$P_{IN} = -25\text{ dBm}$.
Noise Figure	NF		4.2		dB	On standard evaluation board.
Saturated Output Power	P_{SAT}	33.8	35.3		dBm	$P_{IN} = 0\text{ dBm}$.
Power Added Efficiency (at P_{SAT})	PAE		61		%	$P_{IN} = 0\text{ dBm}$.
Output 1 dB Compression Power	OP1dB		34.3		dBm	CW input.
Switching Rise Time	T_{RISE}		14		μs	At P_{SAT} .
Switching Fall Time	T_{FALL}		1		μs	At P_{SAT} .

GRF5504 Typical Operating Curves: 450 to 470 MHz Tune

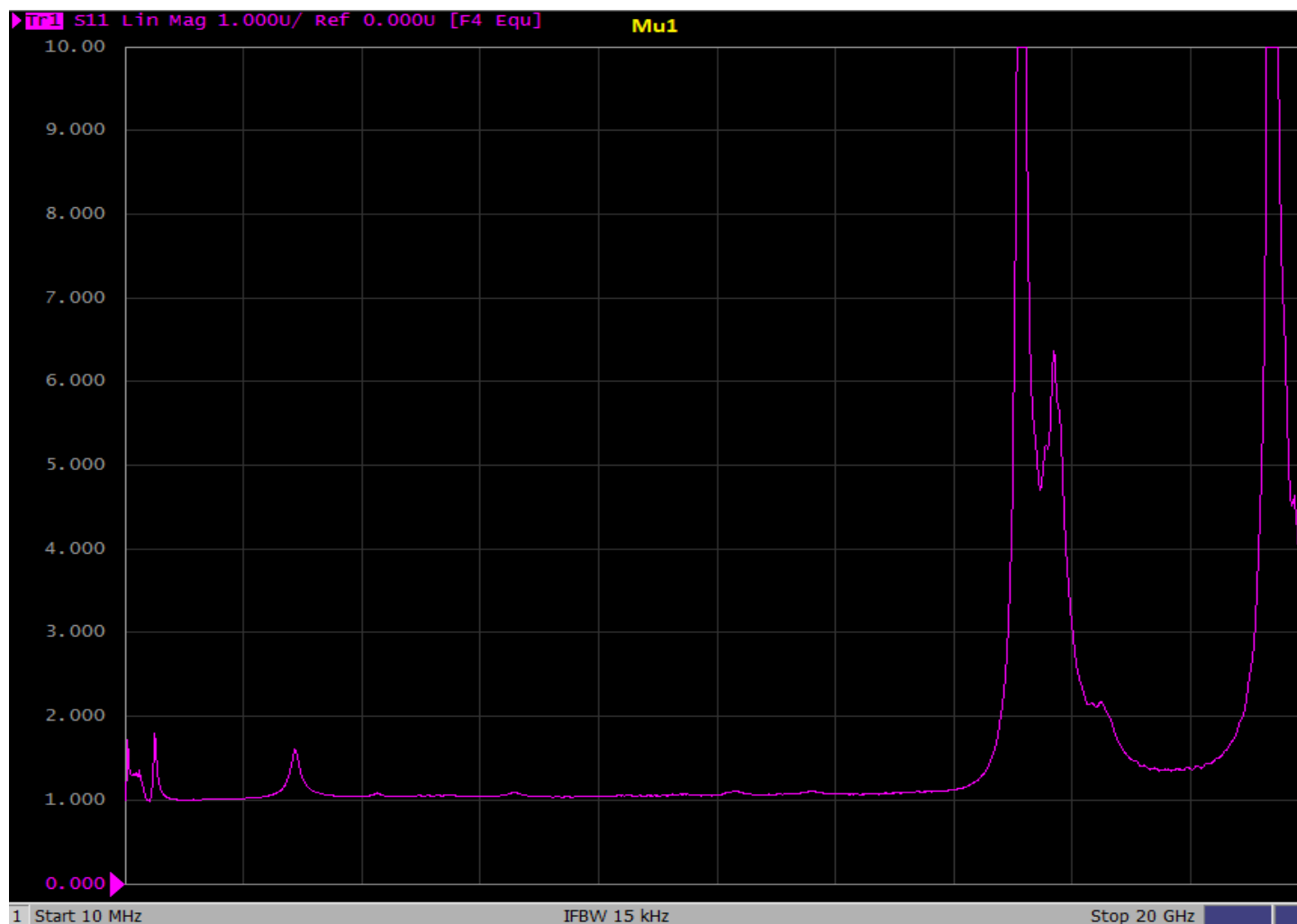


GRF5504 Typical Operating Curves: 450 to 470 MHz Tune



GRF5504 Typical Operating Curves: S-Parameters (450 to 470 MHz Tune)


GRF5504 Typical Operating Curves: Stability Mu (10 MHz to 20 GHz)



Note: Mu factor ≥ 1.0 implies unconditional stability

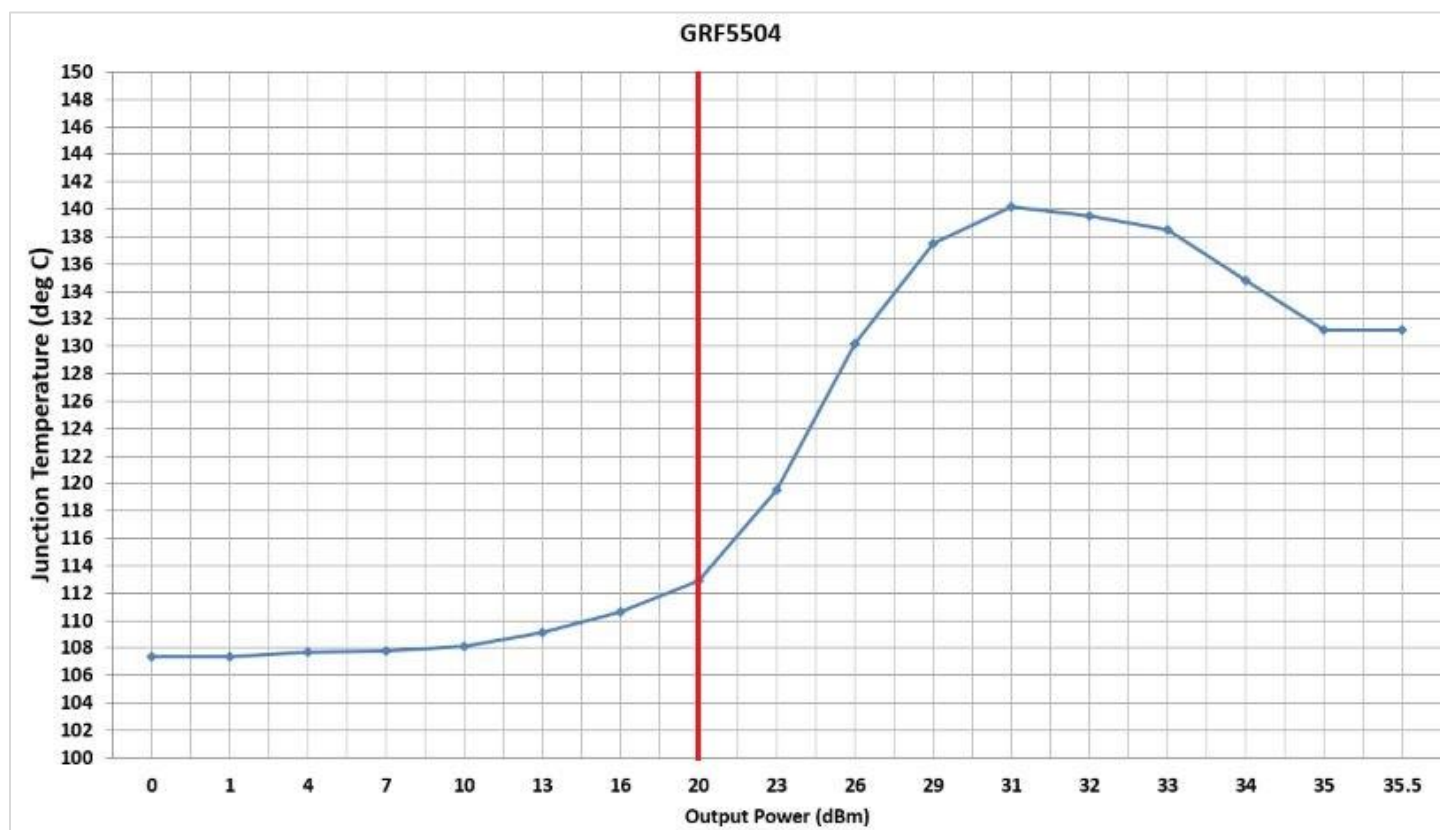
GRF5504 Junction Temperature (per application schematic at 85 °C)

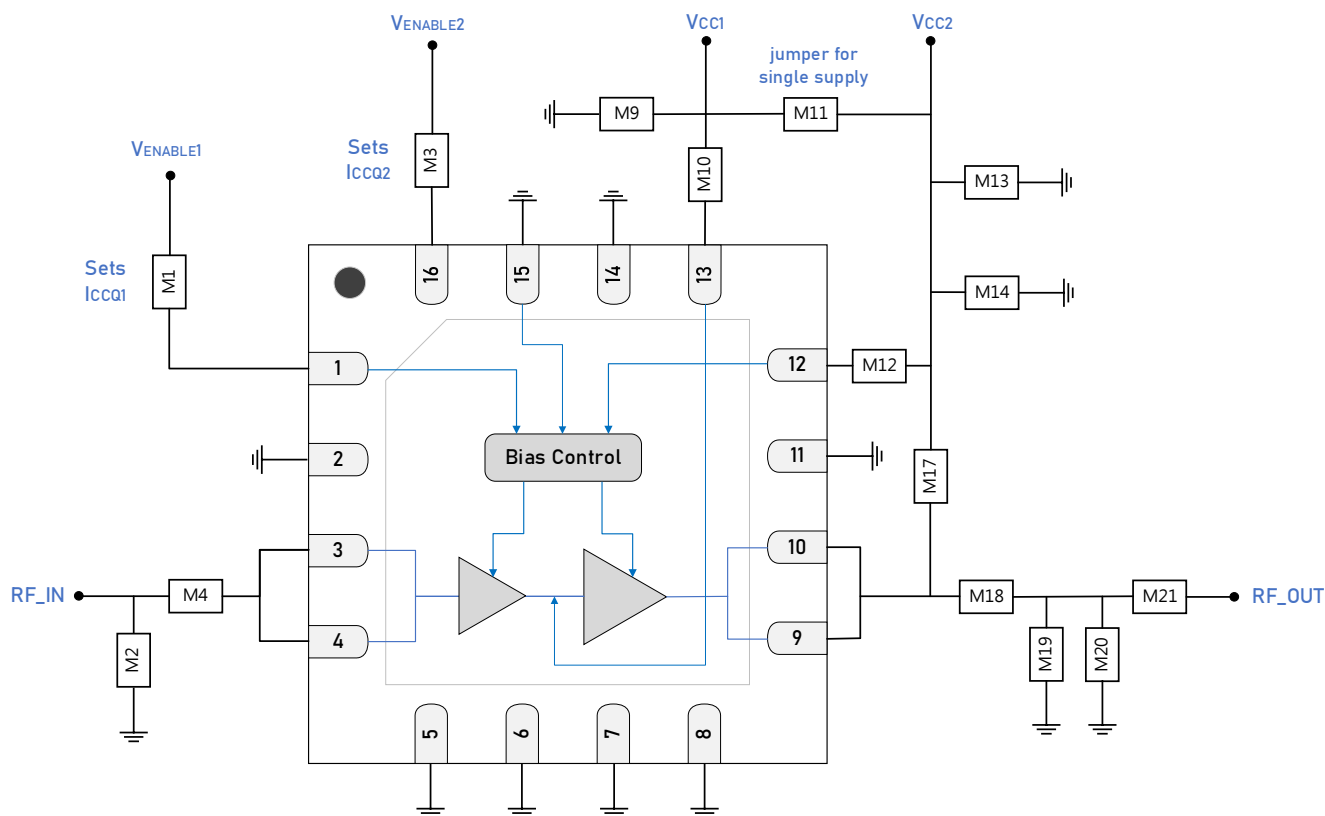
GRF5504 being a 2-stage device sees one of the stages governing junction temperature over power sweep.

Red line = 20 dBm where T_j is equivalent in both stages.

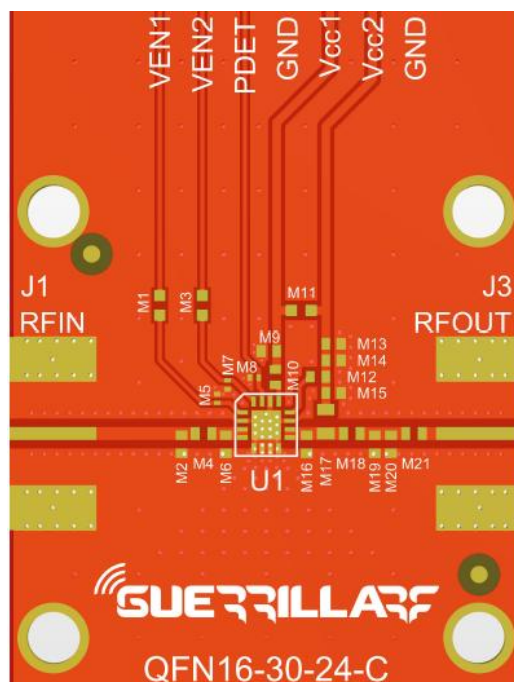
At left of the red line, stage 1 governs T_j (Q1 T_j is higher).

To the right of the red line, stage 2 governs T_j (Q2 T_j is higher).





GRF5504 Standard Evaluation Board Schematic



GRF5504 Evaluation Board Assembly Diagram

GRF5504 Evaluation Board Assembly Diagram Reference: 450 to 470 MHz Tune

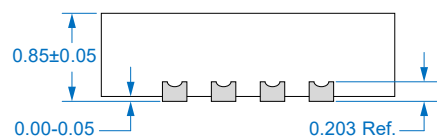
Component	Type	Manufacturer	Family	Value	Package Size	Substitution
M1	Resistor	Various	5%	See Table	0402	ok
M2	Inductor	Murata	LQG	8.2 nH	0402	ok
M3	Resistor	Various	5%	See Table	0402	ok
M4	Capacitor	Murata	GJM	20 pF	0402	ok
M9	Capacitor	Murata	GRM	0.1 μ F	0402	ok
M10	Inductor	Coilcraft	HP	5.6 nH	0402	ok
M11	Resistor (jumper)	Various	5%	0 Ω	0402	ok
M12	Resistor (jumper)	Various	5%	0 Ω	0402	ok
M13	Capacitor	Murata	GRM	0.1 μ F	0402	ok
M14	Capacitor	Murata	GRM	100 pF	0402	ok
M17	Inductor	Coilcraft	0908SQ	23 nH	0908	ok
M18	Inductor	Coilcraft	DC	2.7 nH	0603	ok
M19	Capacitor	Murata	GJM	22 pF	0402	ok
M20	Capacitor	Murata	GJM	3 pF	0402	ok
M21	Capacitor	Murata	GRM	100 pF	0402	ok
M5, M6, M7, M8, M15, M16	DNP					
Evaluation Board	QFN16-30-24-C					

Note: Standard evaluation board bias: $V_{CC} = 5\text{ V}$, $V_{EN1} = V_{EN2} = 5\text{ V}$.

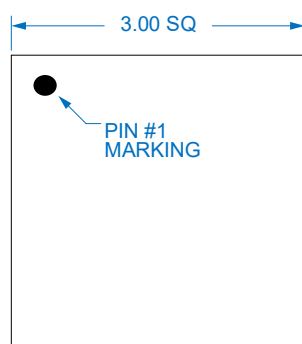
Bias Resistor Selection Table: resistors M1 and M3

$V_{CC1}\text{ (V)}$	$V_{CC2}\text{ (V)}$	$V_{EN1} = V_{EN2}\text{ (V)}$	$I_{CCQ1}\text{ (mA)}$	$I_{CCQ2}\text{ (mA)}$	Bias R M1	Bias R M3
3	3	3	20	50	1.9 k Ω	2.4 k Ω
3.5	3.5	3.5	20	55	2.7 k Ω	4.5 k Ω
4	4	4	22	65	3.3 k Ω	5.7 k Ω
4.5	4.5	4.5	25	75	3.6 k Ω	6.7 k Ω
5	5	5	30	90	3.3 k Ω	6.8 k Ω

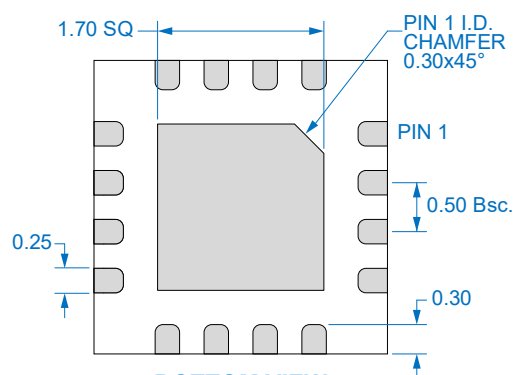
Package Outline Drawing



SIDE VIEW

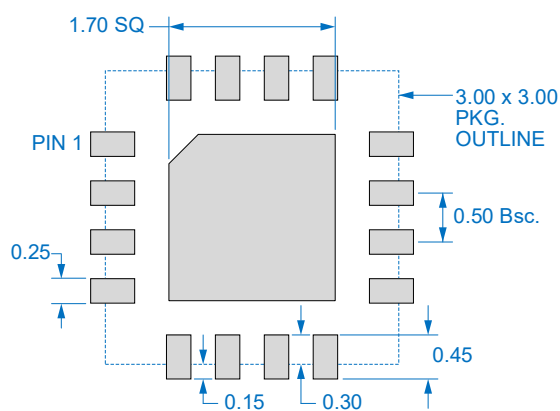


TOP VIEW



BOTTOM VIEW

Recommended PCB Footprint



TOP VIEW

QFN-16 3 x 3 Package Dimensions and Suggested Footprint (Top View)

Package Marking Diagram



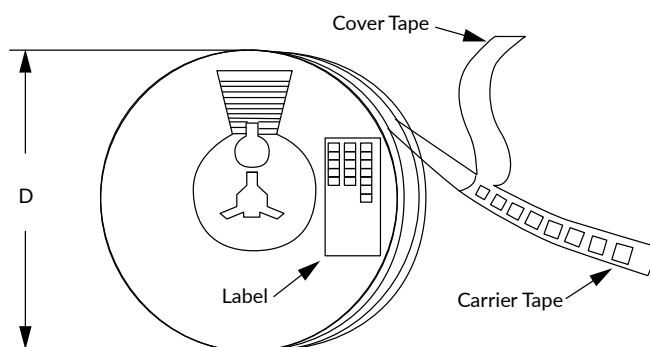
- Line 1: "YY" = YEAR. "WW" = WORK WEEK the device was assembled.
- Line 2: "GRF" = Guerrilla RF.
- Line 3: "XXXX" = Device PART NUMBER.

Tape and Reel Information

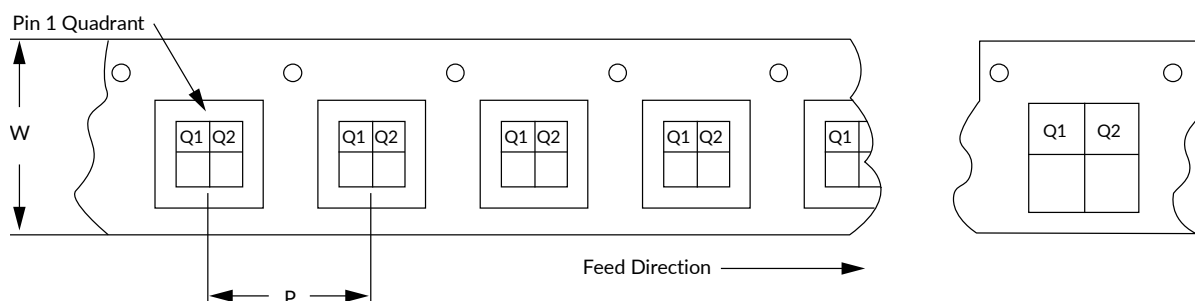
Guerrilla RF's tape and reel specification complies with Electronic Industries Alliance (EIA) standards for "Embossed Carrier Tape of Surface Mount Components for Automatic Handling" (reference EIA-481). See the following page for the Tape and Reel Specification and Device Package Information table, which includes units per reel.

Devices are loaded with pins down into the carrier pocket with protective cover tape and reeled onto a plastic reel. Each reel is packaged in a cardboard box. There are product labels on the reel, the protective ESD bag and the outside surface of the box.

For the Tape and Reel Reference Table, please refer to: <https://www.guerrilla-rf.com/prodFiles/Manufacturing/MN001.pdf>



Tape and Reel Packaging with Reel Diameter Noted (D)



Carrier Tape Width (W), Pitch (P), Feed Direction and Pin 1 Quadrant Information

Revision History

Revision Date	Description of Change
December 19, 2019	Preliminary Data Sheet.
August 25, 2023	Release 0 Data Sheet.
November 7, 2023	Updated thermal resistance (stage 1 & stage 2). Updated junction temperature plot. Added P _{SAT} lower limit specification.
January 9, 2025	Updated M18 & M20 on evaluation board BOM.
January 22, 2025	Lowered low end of frequency range from 300 MHz to 100 MHz.
November 6, 2025	Upgraded Data Sheet to new format only. No change to device or device specifications.



Data Sheet Classifications

Data Sheet Status	Notes
Advance	S-parameter and NF data based on EM simulations for the fully packaged device using foundry-supplied transistor S-parameters. Linearity estimates based on device size, bias condition and experience with related devices.
Preliminary	All data based on limited evaluation board measurements taken within the Guerrilla RF Applications Lab. All parametric values are subject to change pending the collection of additional data.
Release Ø	All data based on measurements taken with <i>production-released</i> material. TYP values are based on a combination of ATE and bench-level measurements, with MIN/MAX limits defined using <i>modelled estimates</i> that account for part-to-part variations and expected process spreads. Although unlikely, future refinements to the TYP/MIN/MAX values may be in order as multiple lots are processed through the factory.
Release A-Z	All data based on measurements taken with production-released material <i>derived from multiple lots which have been fabricated over an extended period of time</i> . MIN/MAX limits may be refined over previous releases as more statistically significant data is collected to account for process spreads.

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